SN54LS21, SN74LS21 DUAL 4-INPUT POSITIVE-AND GATES

SDLS139 - APRIL 1985 - REVISED MARCH 1988

- Package Options Include Plastic "Small Outline" Packages, Ceramic Chip Carriers and Flat Packages, and Plastic and Ceramic DIPs
- Dependable Texas Instruments Quality and Reliability

description

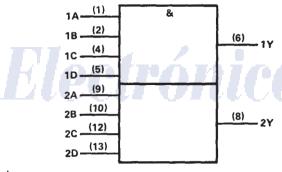
These devices contain two independent 4-input AND gates.

The SN54LS21 is characterized for operation over the full military temperature range of -55°C to 125°C. The SN74LS21 is characterized for operation from 0°C to 70°C.

FUNCTION TABLE (each gate)

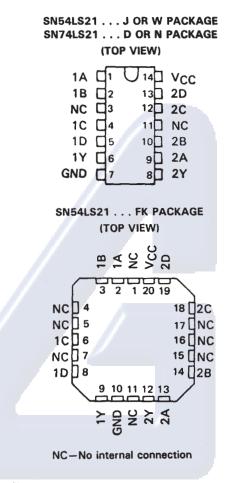
	INP	UTS	ОИТРИТ			
A	В	С	D	Y		
Н	Н	Н	н	Н		
L	X	Х	×	L		
Х	L	Х	X	L		
Х	Х	L	x	L		
X	X	X	L	L		

logic symbol†

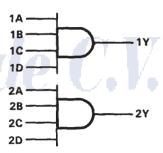


[†] This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

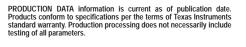
Pin numbers shown are for D, J, N, and W packages.



logic diagram



(positive logic) $Y = A \cdot B \cdot C \cdot D$ or $Y = \overline{A} + \overline{B} + \overline{C} + \overline{D}$

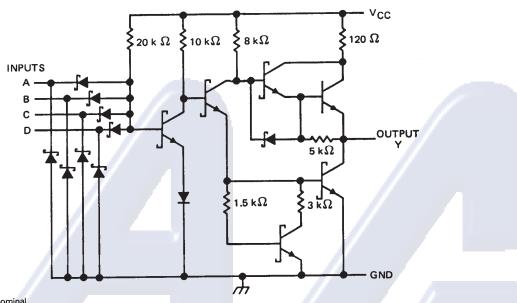




SN54LS21, SN74LS21 DUAL 4-INPUT POSITIVE-AND GATES

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schematics (each gate)



Resistor values shown are nominal.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (see Note 1)	
Input voltage	
Operating free-air temperature range: SI	N54' 55°C to 125°C
SI	N74' 0°C to 70°C
Storage temperature range	65°C to 150°C

NOTE 1: Voltage values are with respect to network ground terminals.

Electrónica S.A. de C.V.



SN54LS21, SN74LS21 DUAL 4-INPUT POSITIVE-AND GATES

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recommended operating conditions

			SN54LS	21	SN74LS21			UNIT
		MIN NOM MAX		MAX	MIN	MIN NOM MAX		
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	٧
VIH	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7		7	0.8	٧
Іон	High-level output current			- 0.4	1		- 0.4	mA
loL	Low-level output current			4	/		8	mA
TA	Operating free-air temperature	- 55		125	0		70	°c

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER			SN54LS21			SN74LS21			UNIT		
	TEST CONDITIONS †			MIN	TYP‡	MAX	MIN	TYP‡	MAX	UNIT	
VIK	V _{CC} = MIN,	I _I = - 18 mA				/	- 1.5			1.5	٧
Voн	V _{CC} = MIN,	V _{IH} = 2 V,	I _{OH} = − 0.4 mA		2.5	3.4		2.7	3.4		V
	V _{CC} = MIN,	VIL = MAX,	IOL = 4 mA		7	0.25	0.4	77	0.25	0.4	V
VOL	V _{CC} = MIN,	VIL = MAX,	I _{OL} = 8 mA	7/				1	0.35	0.5	
4	V _{CC} = MAX,	V _I = 7 V		7/			0.1			0.1	mA
Чн	V _{CC} = MAX,	V _I = 2.7 V					20			20	μА
կը	V _{CC} = MAX,	V ₁ = 0.4 V					- 0.4			- 0.4	mA
IOS§	V _{CC} = MAX				- 20		- 100	- 20	1	– 100	mA
ССН	V _{CC} = MAX,	V _I = 4.5 V				1.2	2.4		1.2	2.4	mA
ICCL	V _{CC} = MAX,	V _I = 0 V				2.2	4.4		2.2	4.4	mA

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

switching characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$ (see note 2)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	TEST CON	MIN TYP	MAX	UNIT	
tPLH .			R _L = 2 kΩ, C _L = 15 pF	C. = 15 oF	8	15	ns
tPHL	Алу	Y		10	20	ns	

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

 $[\]ddagger$ All typical values are at V_{CC} = 5 V, T_A = 25° C § Not more than one output should be shorted at a time, and the duration of the short-circuit should not exceed one second.

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